

Atty. Docket No. P2002,1082 US E (8055-115)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S):

Klaus Hummler

Examiner: J.P. Mondt

SERIAL NO.:

10/051,544

Group Art Unit: 2826

FILED:

January 18, 2002

FOR:

SYSTEM AND METHOD FOR BACK-SIDE CONTACT FOR

TRENCH SEMICONDUCTOR DEVICE

CHARACTERIZATION

Dated: February 24, 2004

Mail Stop Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

TRANSMITTAL OF FORMAL DRAWINGS

Sir:

Applicant submits herewith four (4) sheets of formal drawings depicting FIGS. 1-3B for this application.

Respectfully submitted,

Frank Chau

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CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postpaid in an envelope addressed to the: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on February 24, 2004.

Dated: February 24, 2004

Frank Chau